



100V N-Channel Trench Power MOSFET

General Description

The SJ010N145 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

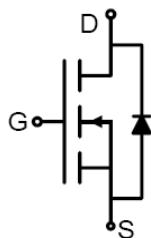
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	100	V
$R_{DS(ON)}_{TYP}$	11.2	$m\Omega$
I_D	65	A
Q_G	20	nC



Schematic Diagram



TO-220 top view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJ010N145	SJ010N145	TO-220	Tube	\	\	1000 Pcs

Table 1. Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	100	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ C$)	65	A
	Drain Current-Continuous($T_c=100^\circ C$)	41	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	260	A
P_D	Maximum Power Dissipation($T_c=25^\circ C$)	137	W
	Maximum Power Dissipation($T_c=100^\circ C$)	55	W
E_{AS}	Avalanche energy (Note 2)	306	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.91	°C/W



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Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	100			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=100\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	μA
		$V_{\text{DS}}=100\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	2		4	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$		37.6		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$		11.2	14.6	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=50\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$		5940		pF
C_{oss}	Output Capacitance			177		pF
C_{rss}	Reverse Transfer Capacitance			165		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$		0.66		Ω
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=50\text{V}$, $R_L=2.5\Omega$, $R_{\text{GEN}}=6\Omega$		11		nS
t_r	Turn-on Rise Time			20		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			25		nS
t_f	Turn-Off Fall Time			20		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=50\text{V}$, $I_{\text{D}}=20\text{A}$		20		nC
Q_{gs}	Gate-Source Charge			6		nC
Q_{gd}	Gate-Drain Charge			6		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				65	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=20\text{A}$			1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		48		ns
Q_{rr}	Reverse Recovery Charge	$I_{\text{F}}=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		80		nC

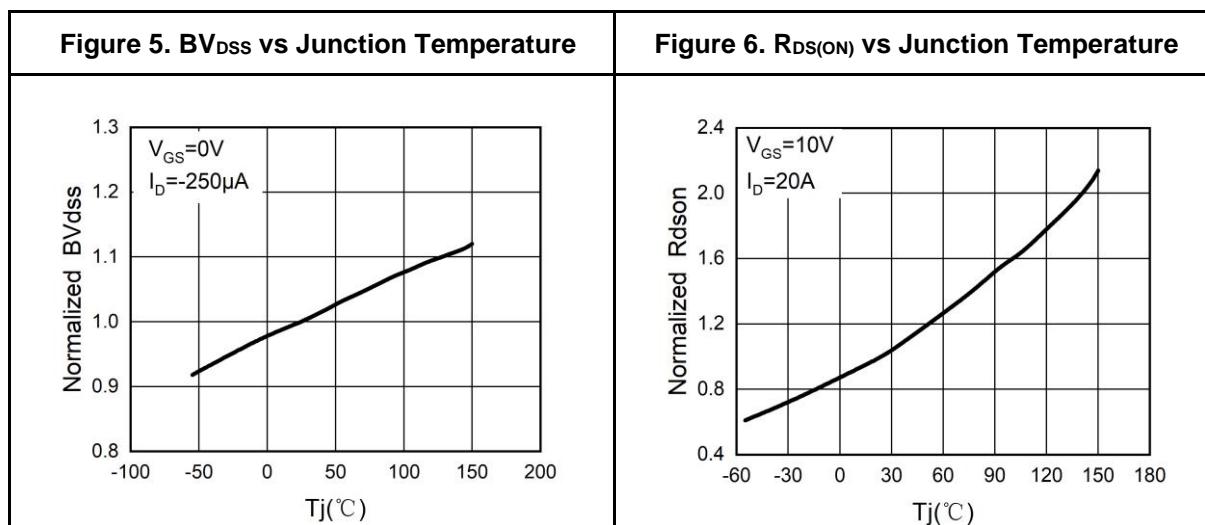
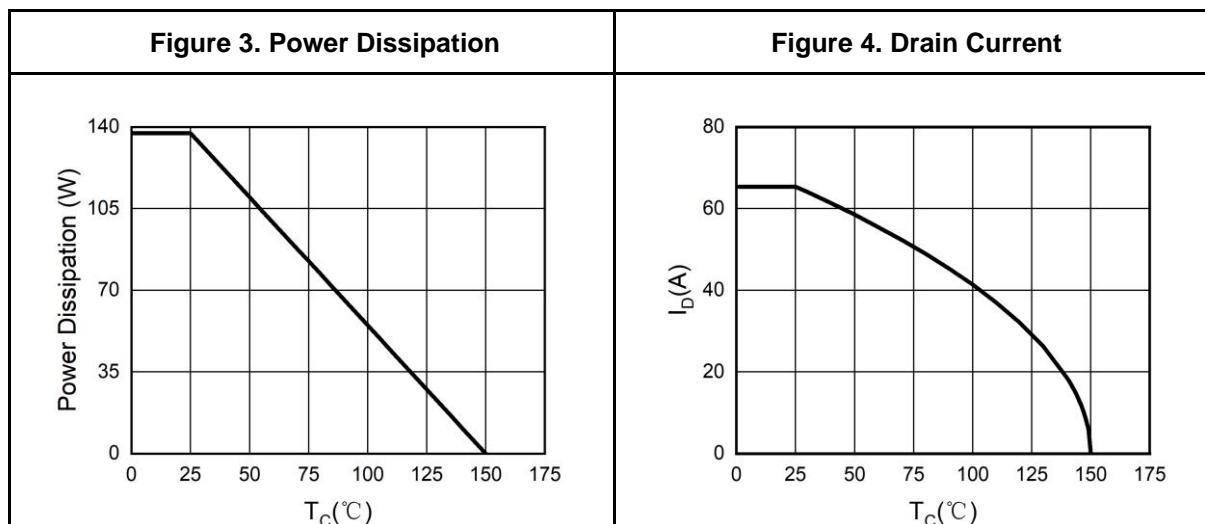
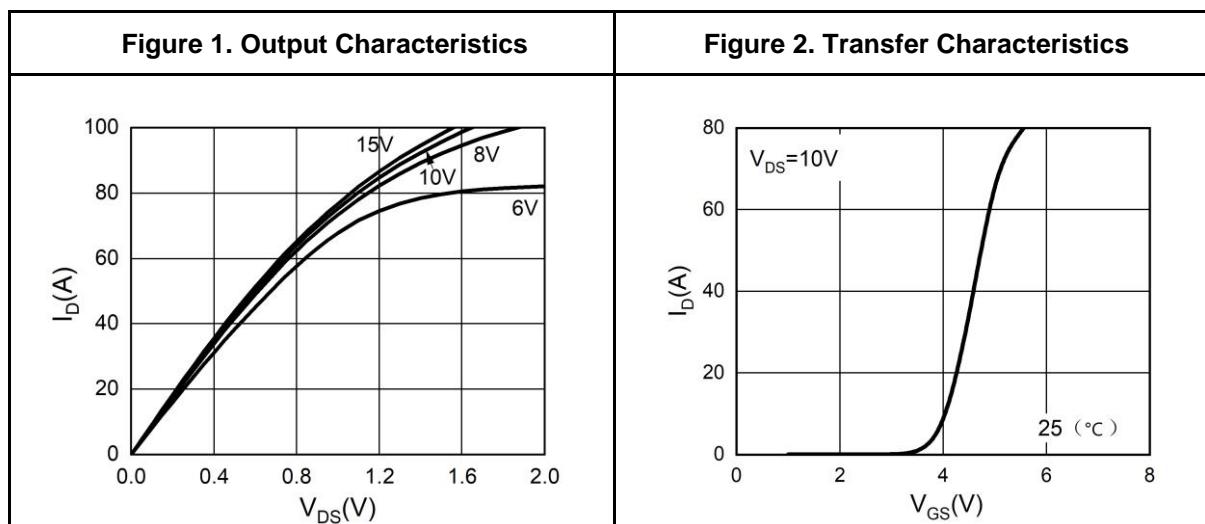
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=50\text{V}$, $V_{\text{G}}=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

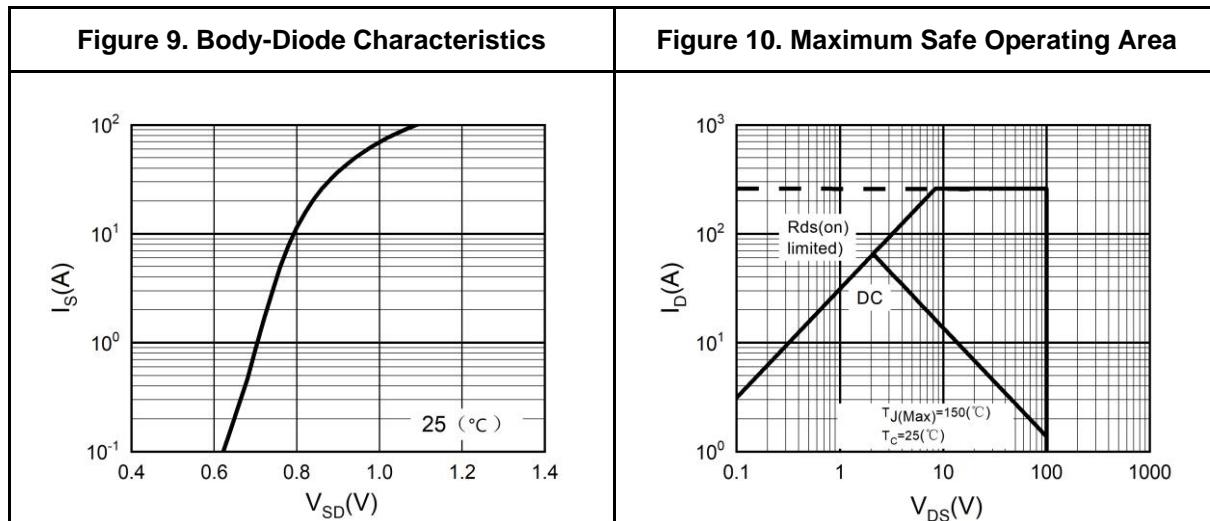
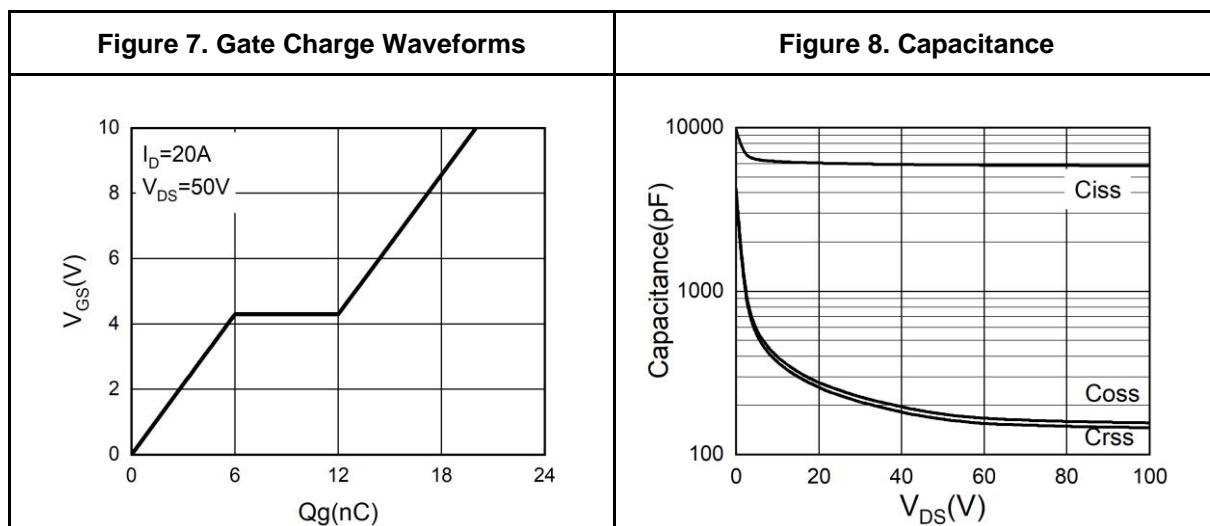


Typical Electrical And Thermal Characteristics (Curves)



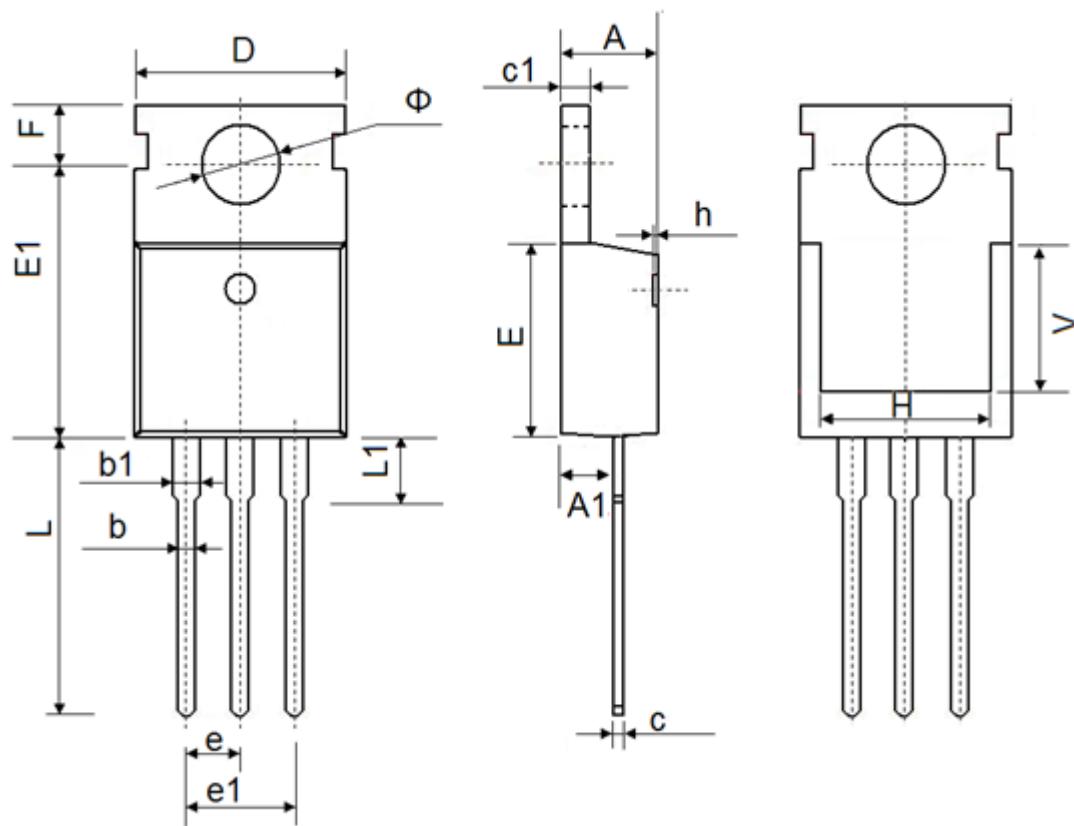


Typical Electrical And Thermal Characteristics (Curves)





TO-220 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max
A	4.300	4.700	0.169	0.185
A1	2.200	2.600	0.087	0.102
b	0.700	0.950	0.028	0.037
b1	1.170	1.410	0.046	0.056
c	0.450	0.650	0.018	0.026
c1	1.200	1.400	0.047	0.055
D	9.600	10.400	0.378	0.409
E	8.8500	9.750	0.348	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.750	14.300	0.502	0.563
L1	2.850	3.950	0.112	0.156
V	7.500 REF.		0.295 REF.	
Φ	3.400	4.000	0.134	0.157



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